

UTC UNISONIC TECHNOLOGIES CO., LTD

15N60

Preliminary

Power MOSFET

15 Amps, 600 Volts **N-CHANNEL MOSFET**

DESCRIPTION

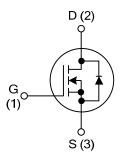
The UTC 15N60 is an N-channel mode Power FET using UTC's advanced technology to provide costumers with planar stripe and DMOS technology. This technology is specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 15N60 is universally applied in active power factor correction and high efficient switched mode power supplies.

FEATURES

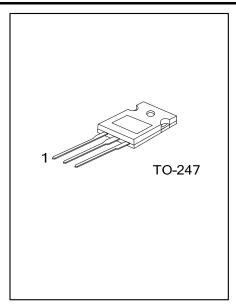
- * 15A, 600V, $R_{DS(ON)}$ =0.44 Ω @ V_{GS}=10V
- * Typically 23.6pF low C_{RSS}
- * High switching speed
- * Improved dv/dt capability

SYMBOL



ORDERING INFORMATION

Ordering Number		Deekege		Pin Assignment			Deaking	
Lead Free	Halogen Free	Package		1	2	3	Packing	
15N60L-T47-T	15N60G-T47-T	TO-247		G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source								
15N60L -T47 - T (1) Packing Type (2) Package Type (3)Lead Free			• • •	Tube 7: TO-247 Halogen		ead Free	9	



■ ABSOLUTE MAXIMUM RATINGS (T_c=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain to Source Voltage			V _{DSS}	600	V
Gate to Source Voltage			V _{GSS}	±30	V
Avalanche Current (Note 1)			I _{AR}	15	А
Continuous Drain Current		Continuous	ID	15	А
		Pulsed (Note 1)	I _{DM}	60	Α
Avalanche Energy	Single	Pulsed (Note 2)	E _{AS}	637	mJ
	Repeti	itive (Note 1)	E _{AR}	25.0	mJ
Peak Diode Recovery dv/dt (Note 3)		dv/dt	4.5	V/ns	
Power Dissipation			PD	312	W
Junction Temperature		T_J	+150	°C	
Storage Temperature			T _{STG}	-55 ~ +150	°C

Note : Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	40	°C/W	
Junction to Case	θ _{JC}	0.4	°C/W	



■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	Э	BV _{DSS}	V _{GS} =0V, I _D =250µA, T _J =25°C	600			V
Breakdown Voltage Temperature Coefficient			I _D =250µA, Referenced to 25°C		0.65		V/°C
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V V _{DS} =520V, T _C =125°C			1 10	μA μA
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse	-000	V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS		I					
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	3.0		5.0	V
Drain-Source On-State Resistand	ce	R _{DS(ON)}	V _{GS} =10V, I _D =7.5A		0.36	0.44	Ω
Forward Transconductance		g fs	V _{DS} =40V, I _D =7.5A (Note 4)		19.2		S
DYNAMIC PARAMETERS		_			_	-	-
Input Capacitance		C _{ISS}			2380	3095	pF
Output Capacitance		Coss	V _{DS} =25V,V _{GS} =0V,f=1.0MHz		295	385	pF
Reverse Transfer Capacitance		C _{RSS}			23.6	35.5	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G			48.5	63.0	nC
Gate-Source Charge		Q_{GS}	V _{DS} =520V, V _{GS} =10V, I _D =15A (Note 4,5)		14.0		nC
Gate-Drain Charge		Q _{GD}	$1_{D} = 15A (1000 \pm 4.5)$		21.2		nC
Turn-ON Delay Time		t _{D(ON)}			65	140	ns
Turn-ON Rise Time		t _R	V _{DD} =325V, I _D =15A,		125	260	ns
Turn-OFF Delay Time		t _{D(OFF)}	R _G =21.7Ω (Note 4,5)		105	220	ns
Turn-OFF Fall Time		t⊨			65	140	ns
SOURCE- DRAIN DIODE RATIN	IGS AND C	HARACTERI	STICS				
Maximum Body-Diode Continuous Current		Is				15	Α
Maximum Body-Diode Pulsed Current		I _{SM}				60	Α
Drain-Source Diode Forward Voltage		V _{SD}	I _S =15A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery T		t _{RR}	V _{GS} =0V, I _S =15A,		496		ns
Body Diode Reverse Recovery C		Q _{RR}	dl _F /dt=100A/µs (Note 4)		5.69		μC

Notes : 1. Repetitive Rating : Pulse width limited by maximum junction temperature

2. L=5.23mH, I_{AS}=15A, V_{DD}= 50V, R_G=25 Ω , Starting T_J=25°C

3. $I_{SD} \le 15A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J=25^{\circ}C$

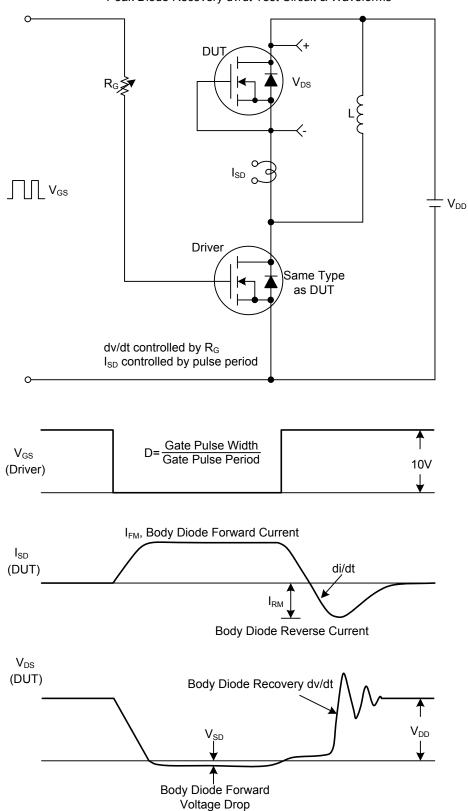
4. Pulse Test : Pulse width ≤ 300 μ s, Duty cycle ≤ 2%

5. Essentially independent of operating temperature

6. Drain current limited by maximum junction temperature



TEST CIRCUITS AND WAVEFORMS

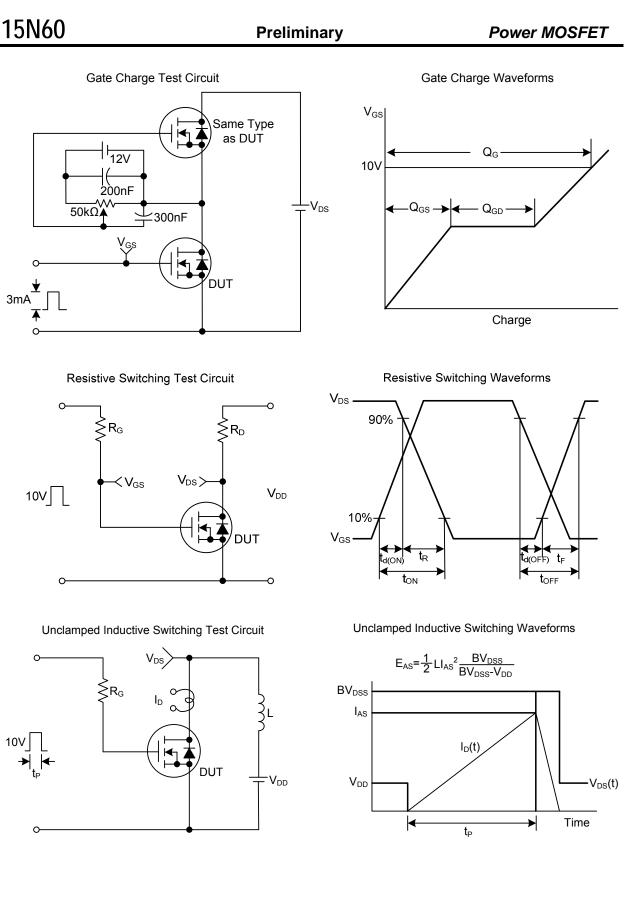


Peak Diode Recovery dv/dt Test Circuit & Waveforms





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